Thermal Interface Materials (TIMs)

Metal TIMs have higher thermal conductivity than non-metals, including greases.

Keys to deciding the best metal TIM include:

- Thermal conductivity requirements
- Compressibility/pressure available
- Operating temperature of the device

Advantages of metal TIMs:

- No pump-out or bake-out, as with thermal greases
- No surface preparation is required and clean-up is easy
- Available in standard and custom shapes and thicknesses
- Heat-Spring[®] pattern gives better contact between surfaces to eliminate air voids

Contact our engineers: askus@indium.com Learn more: www.indium.com

All of Indium Corporation's solder paste and preform manufacturing facilities are IATF 16949:2016 certified. Indium Corporation is an ISO 9001:2015 registered company.

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Thermal Interface Materials (TIM)

Metal TIMs available:

- Solder TIMs: Pure indium, InAg, flux-coated available
- Compressible TIMs: Heat-Spring[®]
- Liquid Metal TIMs: GalliTHERM™ Ga-based liquid metal and liquid metal paste



• Phase Change TIMs: Applied as a solid and the heat source changes the physical state of the TIM to a liquid metal

Metal TIMs for burn-in applications

Because of the high thermal conductivity of 86W/mK, indium is ideal for burn-in and test applications. Pure indium can be clad with a thin aluminum layer (on the side facing the DUT) to prevent the indium from adhering to the surface.

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